Theory of magnetic bipolar transistors

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The concept of a magnetic bipolar transistor (MBT) is introduced. The transistor has at least one magnetic region (emitter, base, or collector) characterized by spin-splitting of the carrier bands. In addition, nonequilibrium (source) spin in MBTs can be induced by external means (electrically or optically). The theory of ideal MBTs is developed and discussed in the forward active regime where the transistors can amplify signals. It is shown that source spin can be injected from the emitter to the collector. It is predicted that electrical current gain (amplication) can be controlled electrically by magnetic eld and source spin.

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Ideally, novel electronics applications build on the existing technologies with as little added complexity as possible, while providing greater capabilities and functionalities than the existing devices. Such is the promise of sem iconductor spintronics [1] which aims at developing novel devices (utilizing electron spin, in addition to charge { which would provide spin and magnetic control of electronics and, vice versa, electronic control over spin and magnetism. Potential applications of semiconductor spintronics range from nonvolatile computer mem ories to spin-based quantum computing [1]. One particular promising im plem entation of sem iconductor spintronics is bipolar spintronics [1] which combines spin and charge transport of both electrons and holes in (generally magnetic) sem iconductor heterostructures to control electronics. In this Letter we propose a novel device scheme (magnetic bipolar (junction) transistor (MBT) { which, while in design a minor modi cation of the existing charge-based hetoro junction transistor (in fact, m aterials needed to fabricate MBTs are already available), has a great potential for extending functionalities of the existing device structures, since, as is demonstrated here, its current gain (am pli cation) characteristics can be controlled by magnetic eld and spin.

As sem iconductor spintronics itself, bipolar spintronics still relies rather on experim entally dem onstrated fundam entalphysics concepts (such as spin in jection [2, 3, 4, 5], spin Itering [6], or sem iconductor ferrom agnetism [7]) than on demonstrated working devices. But the recent experiments [8, 9] on spin in jection through bipolar tunnel junctions clearly prove the potential of spinpolarized bipolar transport for both interesting fundamental physics and useful technological applications. We have recently shown theoretically that indeed spinpolarized bipolar transport is a source of novel physical e ects and device concepts [10, 11, 12, 13]. In particular, we have analyzed the properties of magnetic junction diodes, demonstrating spin injection, spin capacitance, giant m agnetoresistance, and a spin-voltaic e ect. Here we formulate an analytic approach to study magnetic bipolar transistor (which is a very dierent structure from the earlier spin transistors [14,15]), incorporating two magnetic p-n junctions in sequence. The step from a diode to a transistor is nontrivial conceptually as it introduces new phenomena, most notably current amplication. Our two major ndings are: source spin can be injected across a transistor and electrical gain can be controlled by spin and magnetic eld.

A scheme of MBT is shown in Fig. 1. We consider an npn transistor with spin-split conduction bands (the splitting is proportional to magnetic eld and is amplied by magnetic doping) and with source spin (which is incorporated here through boundary conditions) in jected, in principle, to any region. Source spin, in addition to applied bias, brings about nonequilibrium carrier population and thus electrical current. In the following we generalize the theory developed for magnetic p-n junctions [13] to study magnetic transistor structures. All the assumptions of that theory apply here. Most important, carriers obey nondegenerate Boltzmann statistics, nonequilibrium carrier densities are smaller than the doping densities (the low in jection or low bias lim it), and carrier recombination and spin relaxation is neglected in the depletion layers. Further, we express voltages in the units of therm alenergy $k_{\text{B}}\;T$, and m ake them $\;positive\;for\;$ forward biasing.

Our rst task is to obtain the electron and spin densities at the two depletion layers. Once these are known, the density pro les can be calculated using the formulas provided in Tab. II of Ref. 13. In the following the quantities at the emitterbase (collector-base) depletion layer edges carry index 1 (2). To simplify complex notation we adopt term inology that is useful in treating an arbitrary array of magnetic p-n junctions, though here we limit ourselves to MBT which is the smallest nontrivial array of such kind. We denote by scalar uthe nonequilibrium spin density in the nonequilibrium electron (the rst component) and spin (the second component) densities in the pregions (here only base b). The boundary

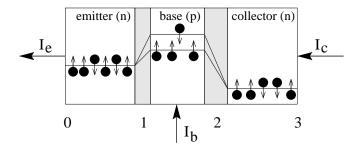


FIG. 1: Scheme of a magnetic npn transistor. Shown are conduction bands in each region. Only the base is magnetic in the gure. The forward bias applied to junction 1 lowers the electrostatic barrier for electrons to cross from the emitter to the base, while the reverse bias in junction 2 increases the barrier in that junction. The shaded regions around the junctions are the depletion layers.

conditions are speci ed by u and v at the emitter and collector contacts to the external electrodes. In our case the boundary spin densities are u_0 and u_3 which are to be treated as input parameters. The notation inside the array follows the indexing of the junctions. For example, v_2 is the nonequilibrium density vector in the p side at the second depletion layer edge (in our case it is the density in the base at the become capitation layer). The values of u_1 , v_1 , etc. need to be obtained self-consistently requiring [13] that the (spin-resolved) chemical potentials and spin currents are continuous across the depletion layers. The following is the basic set of equations describing the coupling of charge and spin (the coupling is both intra- and inter-junction) in the magnetic transistor system [13]:

$$u_1 = u_{11}u_0 + C_1$$
 (1)

$$v_1 = v_1^0 + D_1 u_1; (2)$$

for junction 1, and

$$u_2 = 0; 2u_3 + C_2$$
 [3]

$$v_2 = v_2^0 + D_2 u_2;$$
 (4)

for junction 2. The notation goes as follows. For a general junction $v^0 = [exp(V) \quad 1](n_{0p};s_{0p})$ is the nonequilibrium density vector due to applied bias (across the junction) V (but no source spin), C = [0p(2)], and

$$D = \frac{n_{0p}e^{V}}{N_{d}} \frac{1}{1 + \frac{2}{0n}} (o_{p} o_{n}; 1 o_{p} o_{n}) : (5)$$

Symbol n_{0p} (s_{0p}) stands for the electron (spin) equilibrium density in the p region of the junction, N_d is the donor doping density of the n-region, and o_{0n} (o_{0p}) is the equilibrium electron spin polarization (the ratio of spin and electron density) in the n (p) region adjacent to the junction. The geometric/transport factors o_{0p} through o_{0p} are determined from carrier di usivities, carrier recombination and spin relaxation times, and electron equilibrium.

of the adjacent bulk regions [13]. We note that equations analogous to Eqs. $1\{4 \text{ can be written for holes, if their polarization is taken into account. The solution to Eqs. <math>1\{4 \text{ is}$

$$u_2 = {}_{0;1} (C_2 \quad p) u_0 + {}_{0;2} u_3 + C_2 \quad v;$$
 (6)

where we have neglected term soforder $[n_{0p} \exp(V)] = N_d \int_0^2 v$, consistent with the small injection limit. The formulas for u_1, v_1 , and v_2 can be obtained directly by substituting Eq. 6 for u_2 into Eqs. 1 through 4.

Equation 6 describes spin injection through MBT, since u_2 is the nonequilibrium spin in the collector at the depletion layer with the base. The rst term on the right-hand side (RHS) of Eq. 6 represents transfer of source spin u_0 from the emitter to the collector. Indeed, for a nonmagnetic transistor (the equilibrium spin polarizations are zero) the transferred source spin is $u_3 = 0; 1; 2n_{0b} \exp(V_1)u_0$. Here 0 describes the transfer of source spin through the emitter (majority carrier spin injection. Once the spin is in the base, it becomes the spin of the minority carriers [hence the minority density factor $n_{0b} \exp (V_1)$], di using towards the b cdepletion layer. The built-in electric eld in this layer sweeps the spin into the collector, where it becomes the spin of the majority carriers again, by the process of minoritycarrier spin pumping [10, 13]. Can the injected spin polarization in the collector be greater than the source spin polarization? The answer is negative in the low-injection regime. It would be tempting to let the spin diusion length in the collector to increase to large values to get a greater pum ped spin. But that would increase the im portance of electric eld in the n-regions and the theory (which is based on charge and spin di usion and not spin drift) would cease to be valid. However, the spin density in the collector can be greater than that in the base (as illustrated in the exam ple below), demonstrating that spin spatial decay is not, in general, monotonically decreasing. The second term on the RHS of Eq. 6 results from diffusion of the source spin in the collector (described by 0:2). Finally, the third term, which is independent of source spin, results from the (intrinsic) spin pumping by the minority channel of nonequilibrium spin generated in the base by the forward current through junction 1. This term vanishes if the base is nonmagnetic ($_{0b} = 0$).

To illustrate spin injection across MBT we plot in Fig. 2 the calculated electron and spin density pro less in a Si-based magnetic npn transistor with magnetic base (and nonmagnetic emitter and collector) and with source spin in the emitter. The geometry of the device is depicted at the top of the gure. The emitter, base, and collector are doped (respectively) with N $_{\rm e}=10^{17}$, N $_{\rm b}=10^{16}$, and N $_{\rm c}=10^{15}$ donors, acceptors, and donors per cm 3 . The carrier and spin relaxation times are taken to be 0.1 s (it is not clear what spin relaxation times of conduction electrons in Si should be [16], but due to the small spin-orbit coupling they are expected to be on the

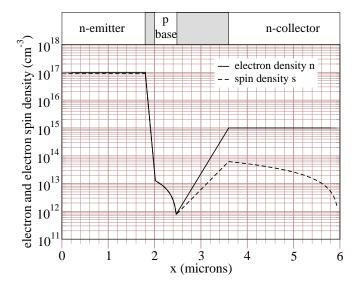


FIG. 2: Calculated electron and spin density pro les in a Sibased npn transistor with magnetic base and source spin in the emitter. The transistor geometry is shown at the top. The densities inside the depletion layers are not calculated, and are shown here (with no justication beside guiding the eye) as straight lines connecting the densities at the depletion layer edges.

order of sub-microseconds, rather than sub-nanoseconds as in G aAs), the electron (hole) di usivities are D $_{\rm n} = 100$ $(D_p = 10)$ cm²s¹, the dielectric constant is 12, and the intrinsic carrier concentration is $n_i = 10^{10}$ cm³. The transistor is at room temperature. The applied biases are $V_1 = V_{be} = 0.5$ volts and $V_2 = V_{bc} =$ volts. The spin splitting of the base conduction band is $2_b = 2$ (in $k_B T$), yielding the equilibrium spin polarization $0b = \tanh(b) = 0.76$; the source spin polarization at the em itter (at x = 0) is $u_0 = N_D = 0.9$. Finally, we assum e charge and spin ohm ic contact at x = 3, m eaning that both carrier and spin densities are at their equilibrium levels. Figure 2 dem on strates that spin in jection is possible all the way from the em itter, through the base, down to the collector. The density of the injected spin in the collector depends on many factors, most notably on the forward bias V be and on the spin di usion lengths in the base and in the collector. The spin density (but not spin polarization) even increases as one goes from the base to the collector, consistent with our notion of spin amplication [10, 13]. The injected spin polarization $u_2=N_c$ in the above example is about 2%, but it would be greater for higher V_{be} , longer spin relaxation tim es, and sm aller base widths.

We now turn to the question of current gain (amplication) and its controlby magnetic eld (through $_{\rm b}$) and source spin (through $_{\rm e}$, the nonequilibrium spin polarization in the em itter at junction 1). Electric currents are readily evaluated once the nonequilibrium carrier densities at the depletion layers are known. Thus the em itter

airrent.

$$j_{e} = j_{gb}^{n} \frac{n_{be}}{n_{0b}} \qquad j_{gb}^{n} \frac{1}{\cosh (w_{b} = L_{nb})} \frac{n_{bc}}{n_{0b}} + j_{ge}^{p} \frac{p_{be}}{p_{0e}}; \quad (7)$$

and the collector current

$$\dot{j}_{c} = -\frac{1}{3} \frac{n_{bc}}{n_{0b}} + j_{gb}^{n} \frac{1}{\cosh (w_{b} = L_{nb})} \frac{n_{be}}{n_{0b}} + j_{gc}^{p} \frac{p_{bc}}{p_{0c}}; \quad (8)$$

where we denote the generation currents for electrons and holes (with the indexing of the appropriate region) respectively as [13] $j_g^n = (qD_n = L_n) n_0 \coth (w = L_n)$, and $j_g^p = (qD_p = L_p) p_0 \coth (w = L_p)$. Here q is the proton charge, L_n (L_p) is the electron (hole) m inority di usion length, and w is the electron (tole) m inority di usion length, and w is the electron (tole) width of the region; n (p) are the nonequilibrium electron (hole) densities at the corresponding depletion layer. In the active control regime ($V_{be} > 0$ and $V_{bc} < 0$) the hole collector current and the current driven by the nonequilibrium density n_{bc} becomes negligible. Finally, the base current is given by the current continuity (see Fig. 1) as $j_0 = j_e$.

The current ampli cation factor is the ratio of the collector current to the base current (if is large, typically about 100, small changes in j_b lead to large variations in j_c). For illustration we consider only the case of magnetic base and emitter source spin, and consider (as is typically done in transistor physics) thin bases ($w_b = L_{nb}$; L_{sb} where L_{sb} is the spin diusion length in the base). The gain of MBT can then be written as $= 1 = (\ ^0_T + \ ^0_c)$, where

$$_{\rm T}^{0} = (w_{\rm b} = L_{\rm nb})^{2} = 2;$$
 (9)

and

$$^{0} = \frac{N_{b}D_{pe}}{N_{e}D_{nb}} \frac{w_{b}}{L_{pe} \tanh (w_{e}=L_{pe})} \frac{1}{\cosh (b) (1 + e 0b)};$$
(10)

The two factors $_{\rm T}^0$ and $_{\rm T}^0$ are related to the usual base transport $_{\rm T}$ and emitter e ciency factor by $_{\rm T}=1$ =(1+ $_{\rm T}^0$) and = 1=(1+ $_{\rm T}^0$). They represent, respectively, the contribution to the gain by the carrier recombination in the base and by the eciency of the electrons injected by the emitter to carry the total charge current in the emitter (for a standard reference on nonmagnetic transistors see, for example, [17]). In MBT the base transport cannot be controlled by either spin or magnetic eld, since it is related only to carrier recombination in the base (one can, however, consider more specic cases where $_{\rm T}^{\rm ho}$ depends on $_{\rm b}$, in which case even $_{\rm T}^{\rm o}$ could be controlled). The emitter eciency, on the other hand, varies strongly with both $_{\rm b}$ and $_{\rm be}$.

Under what circum stances can we control by magnetic eld and spin most e ectively? The answer lies in the relative magnitudes of $_{\text{T}}^{0}$ and $_{\text{T}}^{0}$. In GaAs-base

transistors the two m ight have sim ilar amplitudes, since the carrier recombination is rather fast, although additional band structure engineering (making heterojunctions) usually signicantly enhances 0 at which point 0 m ight dominate. The situation is much more favorable in Si (or Si/Ge) based transistors, which have long carrier recombination times and it is the emitter e ciency 0 which determines the gain. In this case $^{-1}$ = 0 and

$$\cosh (b) (1 + be 0b)$$
: (11)

The gain varies exponentially with b and is asymmetrically m odulated by the magnetic eld, depending on the relative orientation of the magnetic eld and source spin polarization. The physics behind Eq. 11 is quite illum inating. The emitter e ciency is the ratio of the electron em itter current to the total em itter current (which includes the hole current). The electron part of the current depends linearly on the electron m inority carrier density in the base. This density is modulated, separately, by b, which changes the e ective band gap in the material and thus the equilibrium minority carrier density (according to $n_{0b} = n_i^2 \cosh(b) = N_b$ [12, 13], and by the am ount of nonequilibrium spin (through the spin-voltaic e ect [12, 18]). Sim ilar control of gain could be achieved by having a magnetic emitter. In such a case it would be the equilibrium m inority hole density (and thus the hole em itter current) which would be modi ed by magnetic eld, changing the emitter e ciency. All the e ects associated with the conduction band spin splitting can be also observed when the splitting is (also) in the valence

To illustrate the gain controlofm agnetic eld and spin we calculate — for the same npn geometry as in Fig. 2, but now with two di erent sets of materials parameters. Figure 2, top part, is for GaAs (with $n_i=1.8-10^\circ$ cm 3 , dielectric constant of 11, and recombination and relaxation times of 1 ns, keeping all the other parameters unchanged), while the bottom part is for Si. The calculated gain as a function of conduction band spin splitting b in the base is shown in Fig. 3. The source spin polarization $u_0=N_d$ at the emitter is set to 0.9 (which is roughly also be). The gure shows that current gain (amplication) is signicantly in uenced by magnetic eld (which controls the splitting), but much more in Sithan in GaAs, for the reasons stated earlier.

M agnetic bipolar transistor could be also called m agnetic heterostructure transistor. Indeed, MBT's functionality is based on tunability of electronic properties by band structure engineering. In contrast to the standard (nonmagnetic) heterostructure transistors, how ever, MBT's band structure (the spin-split conduction band) is not a xed property, but can change on demand, during the device operation, by changing the magnetic eld. One can also have magnetic heterostructure transistors with variable spin splitting in the base producing magnetic drift [13] of the spin carrying minority carriers (as

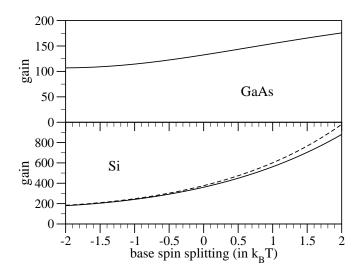


FIG. 3: Calculated gain of a magnetic npn transistor with magnetic base and source spin in the emitter. The upper (lower) graph is for GaAs (Si) materials parameters. The dashed line in the Sigraph is the contribution of the emitter e ciency which controls the current gain in Si-based transistors.

in driff-base transistors) to further enhance spin current and the resulting spin injection into the collector. Interesting e ects could be observed by using ferrom agnetic sem iconductors for the base. Similarly to optical induction of ferrom agnetism by optical injection of carriers [19], emitter can inject (presumably in the high injection limit which goes beyond the scope of our theory) high density carriers into the base, changing the base's magnetic state (on and o, depending on the density of the nonequilibrium minority electrons, or twisting the magnetic moment orientation, if the injected electrons are spin-polarized). This could be an alternative electronic way of switching (or modifying) semiconductor ferrom agnetism [20, 21], which could lead to numerous novel functionalities.

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